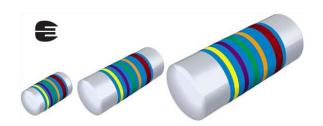


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Professional Thin Film MELF Resistors



MMU 0102, MMA 0204 and MMB 0207 professional thin film MELF resistors are the perfect choice for most fields of modern professional electronics where reliability and stability is of major concern. The typical applications in the fields of automotive, telecommunication and medical equipment reflect the outstanding level of proven reliability.

FEATURES

- Approved according to EN 140401-803
- AEC-Q200 qualified
- Advanced metal film technology
- Excellent overall stability: Exceeds class 0.25
- Sulfur resistance verified according to ASTM B 809
- Material categorization:
 For definitions of compliance please see www.vishav.com/doc?99912

AUTOMOTIVE



ROHS
COMPLIANT
HALOGEN
FREE
GREEN
(5-2008)

APPLICATIONS

- Automotive
- Telecommunication
- Industrial
- Medical equipment

TECHNICAL SPECIFICATIONS							
DESCRIPTION	MMU 0102	MMA 0204	MMB 0207				
DIN size	0102	0204	0207				
Metric CECC size	RC 2211M	RC 3715M	RC 6123M				
Resistance range	0.22 Ω to 2.21 M Ω ; 0 Ω	0.22 Ω to 10 M Ω ; 0 Ω	0.1 Ω to 15 M Ω ; 0 Ω				
Resistance tolerance	±5%;±2%;±1%;±0.5%	± 5 %; ± 1 %; ± 0.5 %	± 5 %; ± 2 %; ± 1 %; ± 0.5 %				
Temperature coefficient	± 50 ppm/K;	± 100 ppm/K; ± 50 ppm/K; ± 25 ppm/K					
Rated dissipation, $P_{70}^{\ (1)}$	0.3 W	0.4 W	1.0 W				
Operating voltage, U _{max.} AC/DC	150 V	200 V	350 V				
Operating temperature range	- 55 °C to 155 °C	- 55 °C to 155 °C	- 55 °C to 155 °C				
Permissible voltage against ambient (insulation):							
1 min, U _{ins}	200 V	300 V	500 V				
Continuous	75 V	75 V	75 V				
Failure rate: FIT _{observed}		≤ 0.1 x 10 ⁻⁹ /h					

Note

APPLICATION INFORMATION

The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature is not exceeded. Furthermore, a high level of ambient temperature or of power dissipation may raise the temperature of the solder joint, hence special solder alloys or board materials may be required to maintain the reliability of the assembly.

These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime. At the maximum permissible film temperature of 155 °C the useful lifetime is specified for 8000 h. The designer may estimate the performance of the particular resistor application or set certain load and temperature limits in order to maintain a desired stability.

⁽¹⁾ Please refer to APPLICATION INFORMATION below.



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MAXIMUM RESISTANCE CHANGE AT RATED DISSIPATION						
OPERATION MODE		STANDARD	POWER			
	MMU 0102	0.2 W	0.3 W			
Rated dissipation, P ₇₀	MMA 0204	0.25 W	0.4 W			
	MMB 0207	0.4 W	1.0 W ⁽¹⁾			
Operating temperature range		- 55 °C to 125 °C	- 55 °C to 155 °C			
Permissible film temperature, \mathcal{G}_{F} max.		125 °C	155 °C			
	MMU 0102	0.22 Ω to 221 k Ω	0.22 Ω to 221 kΩ			
	MMA 0204	0.22 Ω to 332 k Ω	0.22 Ω to 332 k Ω			
Max. resistance change at P_{70} for	MMB 0207	0.22 Ω to 1 M Ω	0.22 Ω to 1 M Ω			
resistance range, $\Delta R/R$ after:	1000 h	≤ 0.15 %	≤ 0.25 %			
	8000 h	≤ 0.3 %	≤ 0.5 %			
	225 000 h	≤ 1.0 %	-			

Note

⁽¹⁾ Specified power rating requires dedicated heat sink pads.

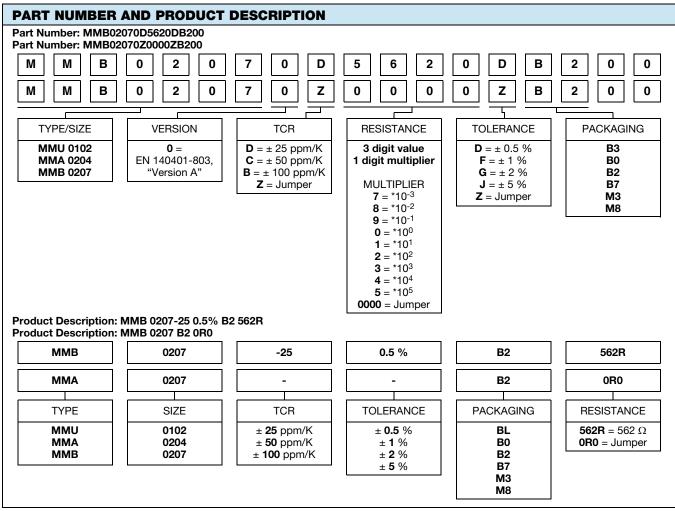
TEMPERATURE COEFFICIENT AND RESISTANCE RANGE								
TYPE/SIZE	TCR	TOLERANCE	RESISTANCE	E-SERIES				
		± 5 %	0.22 Ω to 0.91 Ω	E24				
	. 50 nnm/V	± 2 %	1 Ω to 9.1 Ω	E24				
	± 50 ppm/K	± 1 %	10 Ω to 2.21 M Ω	E24; E96				
MMU 0102		± 0.5 %	10 Ω to 221 kΩ	E24; E192				
	± 25 ppm/K	± 1 %	10 Ω to 221 kΩ	E24; E96				
	± 25 ppm/K	± 0.5 %	10 Ω to 221 kΩ	E24; E192				
	Jumper	-	≤ 10 mΩ; I _{max.} = 2 A	-				
		± 5 %	0.22 Ω to 0.91 Ω	E24				
	± 50 ppm/K	± 1 %	1 Ω to 10 MΩ	E24; E96				
MMA 0204		± 0.5 %	10 Ω to 2.21 MΩ	E24; E192				
IVIIVIA U2U4	05 ///	± 1 %	10 Ω to 511 kΩ	E24; E96				
	± 25 ppm/K	± 0.5 %	10 Ω to 511 kΩ	E24; E192				
	Jumper	-	\leq 10 mΩ; $I_{max.} = 3$ A	-				
	± 100 ppm/K	± 5 %	0.1 Ω to 0.2 Ω					
		± 5 %	0.22 Ω to 0.91 Ω	E24				
MMB 0207	± 50 ppm/K	± 2 %	0.2 Ω to 0.91 Ω					
IVIIVID UZU1		± 1 %	1 Ω to 15 MΩ	E24; E96				
	± 25 ppm/K	± 0.5 %	10 Ω to 1 MΩ	E24; E192				
	Jumper	-	\leq 10 mΩ; $I_{max.} = 5$ A	-				



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PACKAGING										
TYPE/SIZE	CODE	QUANTITY	CARRIER TAPE	WIDTH	PITCH	REEL DIAMETER				
	B3 = BL	3000	Antistatic blister tape acc.	8 mm	4 mm	180 mm/7"				
MMU 0102	В0	10 000	IEC 60286-3 type II	O IIIIII	4 111111	330 mm/13"				
	M8	M8 8000 Bulk case acc. IEC 60286-6		-	-	-				
	B3 = BL	3000	Antistatic blister tape acc.	8 mm	4 mm	180 mm/7"				
MMA 0204	В0	10 000	IEC 60286-3 type II	0 111111	4 111111	330 mm/13"				
	МЗ	3000	Bulk case acc. IEC 60286-6	-	-	-				
MMP 0207	B2	2000	Antistatic blister tape acc.	12 mm	4 mm	180 mm/7"				
MMB 0207	B7	7000	IEC 60286-3 type II	12 [[[[]]	4 mm	330 mm/13"				



Note

• Products can be ordered using either the PART NUMBER or the PRODUCT DESCRIPTION.

VISHAY.

MMU 0102, MMA 0204, MMB 0207 - Professional

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DESCRIPTION

Production is strictly controlled and follows an extensive set of instructions established for reproducibility. A homogeneous film of metal alloy is deposited on a high grade ceramic body (Al₂O₃) and conditioned to achieve the desired temperature coefficient. Nickel plated steel termination caps are firmly pressed on the metallised rods. A special laser is used to achieve the target value by smoothly cutting a helical groove in the resistive layer without damaging the ceramics. The resistor elements are covered by a protective coating designed for electrical, mechanical and climatic protection. The terminations receive a final pure tin on nickel plating. Four or five colour code rings designate the resistance value and tolerance in accordance with **IEC 60062** (1).

The result of the determined production is verified by an extensive testing procedure performed on 100 % of the individual resistors. This includes full screening for the elimination of products with a potential risk of early field failures (feasible for $R \ge 10~\Omega$) according to EN 140401-803, 2.1.2.2. Only accepted products are laid directly into the blister tape in accordance with **IEC 60286-3, Type II** (1) or bulk case in accordance with **IEC 60286-6** (1).

ASSEMBLY

The resistors are suitable for processing on automatic SMD assembly systems. They are suitable for automatic soldering using wave, reflow or vapour phase as shown in **IEC 61760-1** ⁽¹⁾. The encapsulation is resistant to all cleaning solvents commonly used in the electronics industry, including alcohols, esters and aqueous solutions. The suitability of conformal coatings, if applied, shall be qualified by appropriate means to ensure the long-term stability of the whole system.

The resistors are completely lead (Pb)-free, the pure tin plating provides compatibility with lead (Pb)-free and lead containing soldering processes. Solderability is specified for 2 years after production or requalification, however, excellent solderability is proven after extended storage in excess of 10 years. The permitted storage time is 20 years. The immunity of the plating against tin whisker growth has been proven under extensive testing.

All products comply with the **JIG 101** list of legal restrictions on hazardous substances.

This includes full compliance with the following directives:

- 2000/53/EC End of Life Vehicle Directive (ELV) and Annex II (ELV II)
- 2011/65/EU Restriction of the use of Hazardous Substances Directive (RoHS)
- 2002/96/EC Waste Electrical and Electronic Equipment Directive (WEEE)

APPROVALS

The resistors are approved within the IECQ-CECC Quality Assessment System for Electronic Components to the detail specification **EN 140401-803** which refers to **EN 60115-1**, **EN 140400** and the variety of environmental test procedures of the **IEC 60068** ⁽¹⁾ series.

Conformity is attested by the use of the CECC logo () as the mark of conformity on the package label. Vishay Beyschlag has achieved "Approval of Manufacturer" in accordance with IECQ 03-1. The release certificate for "Technology Approval Schedule" in accordance with CECC 240001 based on IECQ 03-3-1 is granted for the Vishay Beyschlag manufacturing process.

The resistors are qualified according to AEC-Q200.

RELATED PRODUCTS

For products with precision specification see the datasheet:

- "Precision Thin Film MELF Resistors" (www.vishav.com/doc?28714)
- "Ultra Precision Thin Film MELF Resistors" (www.vishav.com/doc?28715)

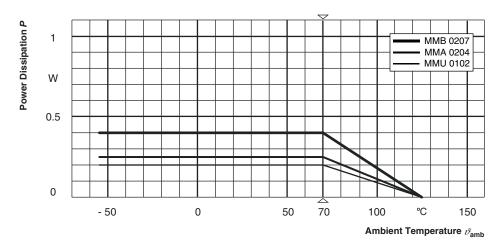
Resistors are available with established reliability in accordance with **EN 140401-803 Version E**. Please refer to datasheet "MELF Resistors with Established Reliability". (www.vishay.com/doc?28707)

Note

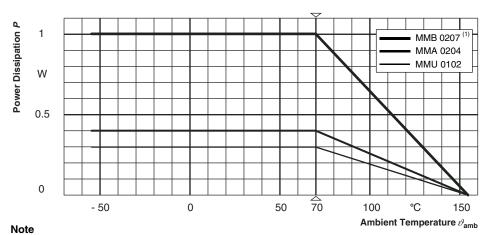
(1) The quoted IEC standards are also released as EN standards with the same number and identical contents.

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FUNCTIONAL PERFORMANCE

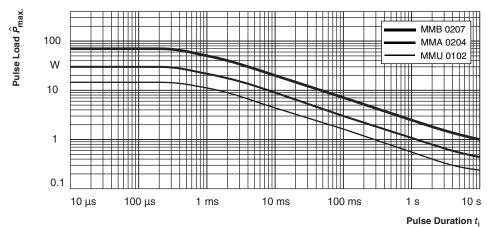


Derating - Standard Operation Mode



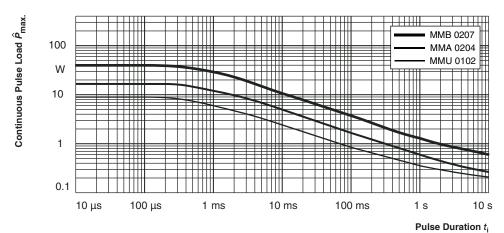
(1) Specified power rating requires dedicated heat sink pads

Derating - Power Operation Mode



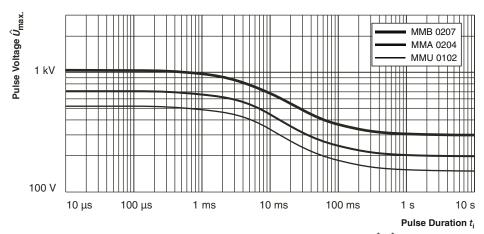
Maximum pulse load, single pulse; applicable if \bar{P} —0 and $n \le 1000$ and $\hat{U} \le \hat{U}_{max.}$; for permissible resistance change equivalent to 8000 h operation in power operation mode

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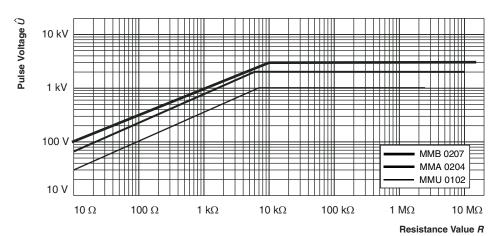
Maximum pulse load, continuous pulses; applicable if $\bar{P} \leq P\left(\left. v_{\text{amb}} \right)$ and $\hat{U} \leq \hat{U}_{\text{max}}$; for permissible resistance change equivalent to 8000 h operation in power operation mode

Continuous Pulse



Maximum pulse voltage, single and continuous pulses; applicable if $\hat{P} \leq \hat{P}_{max}$; for permissible resistance change equivalent to 8000 h operation in power operation mode

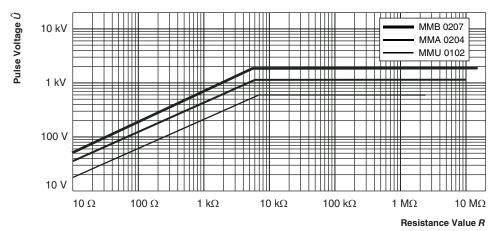
Pulse Voltage



Pulse load rating in accordance with IEC 60 115-1, 4.27; 1.2 μ s/50 μ s; 5 pulses at 12 s intervals; for permissible resistance change (0.5 % x R + 0.05 Ω)

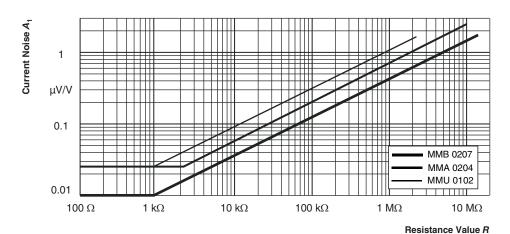
1.2/50 Pulse

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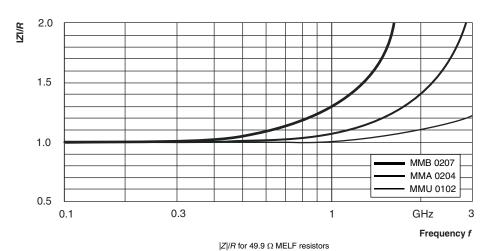
Pulse load rating in accordance with IEC 60115-1, 4.27; 10 μ s/700 μ s; 10 pulses at 1 minute intervals; for permissible resistance change (0.5 % x R + 0.05 Ω)

10/700 Pulse



Accordance with IEC 60195

Current Noise - A₁



RF - Behaviour



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TESTS AND REQUIREMENTS

All tests are carried out in accordance with the following specifications:

EN 60115-1, generic specification (includes tests)

EN 140400, sectional specification (includes schedule for qualification approval)

EN 140401-803, detail specification (includes schedule for conformance inspection)

The components are approved in accordance with the IECQ-CECC-system, where applicable. The following table contains only the most important tests. For the full test schedule refer to the documents listed above. The testing also covers most of the requirements specified by EIA/IS 703 and JIS-C-5202.

The tests are carried out in accordance with IEC 60068 ⁽¹⁾ and under standard atmospheric conditions in accordance with IEC 60068-1 ⁽¹⁾, 5.3. A climatic category temperature is

applied, defined by the lower category temperature (LCT), the upper category temperature (UCT), and the number of days of the damp heat steady state test. (56).

Unless otherwise specified the following values apply:

Temperature: 15 °C to 35 °C Relative humidity: 45 % to 75 %

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar).

The components are mounted for testing on printed-circuit boards in accordance with EN 140400, 2.3.3, unless otherwise specified.

The requirements stated in the Test Procedures and Requirements table are based on the required tests and permitted limits of EN 140401-803. However, some additional tests and a number of improvements against those minimum requirements have been included.

TEST	TEST PROCEDURES AND REQUIREMENTS								
EN 60115-1 CLAUSE	IEC 60068-2 (1) TEST METHOD	TEST	PROCEDURE		REQUIREMENTS PERMISSIBLE CHANGE (△R)				
			Stability for product types:	STABILITY CLASS 0.25 OR BETTER	CLASS 0.25 CLASS 0.5 CLASS 1		STABILITY CLASS 2 OR BETTER		
			MMU 0102	10 Ω to 221 k Ω	1 Ω to < 10 Ω	< 1 Ω	> 221 kΩ		
			MMA 0204	10 Ω to 332 k Ω	1 Ω to < 10 Ω	< 1 Ω	> 332 kΩ		
			MMB 0207	10 Ω to 1 M Ω	1 Ω to < 10 Ω	< 1 Ω	> 1 MΩ		
4.5	-	Resistance	-	± 1 % <i>R</i> ; ± 0.5 % <i>R</i>	± 2 % R; ± 1 % R	± 5 % R	± 1 % R		
4.8.4.2	-	Temperature coefficient	At (20/- 55/20) °C and (20/125/20) °C		± 50 ppm/K,	± 25 ppm/K			
4.25.1	-	Endurance at 70 °C: Standard operation mode Endurance at 70 °C: Power operation mode	$U = \sqrt{P_{70} \times R} \le U_{\text{max.}};$ 1.5 h on; 0.5 h off; $70 \text{ °C}; 1000 \text{ h}$ $70 \text{ °C}; 8000 \text{ h}$ $U = \sqrt{P_{70} \times R} \le U_{\text{max.}};$ 1.5 h on; 0.5 h off; 70 °C; 1000 h $70 °C; 8000 h$	±	(0.15 % R + 10 mΩ ± (0.3 % R + 10 mΩ (0.25 % R + 10 mΩ ± (0.5 % R + 10 mΩ	2)	$\pm (0.5 \% R + 10 m\Omega)$ $\pm (1 \% R + 10 m\Omega)$ $\pm (0.5 \% R + 10 m\Omega)$ $\pm (1 \% R + 10 m\Omega)$		
4.25.3	-	Endurance at upper category temperature	125 °C; 1000 h 155 °C; 1000 h	$\pm (0.15 \% R + 5 \text{ m}\Omega)$ $\pm (0.3 \% R + 5 \text{ m}\Omega)$	\pm (0.25 % R + 5 mΩ) \pm (0.5 % R + 5 mΩ)	\pm (0.5 % R + 5 mΩ) \pm (0.1 % R + 5 mΩ)	± (1 % R + 5 mΩ) ± (2 % R + 5 mΩ)		
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; 56 days; (93 ± 3) % RH	± (0.15 % <i>R</i> + 10 mΩ)	± (0.5 % <i>R</i> + 10 mΩ)	± (0.1 % <i>R</i> + 10 mΩ)	± (1 % <i>R</i> + 10 mΩ)		
4.39	67 (Cy)	Damp heat, steady state, accelerated	(85 ± 2) °C; (85 ± 5) % RH; $U = 0.3 \times \sqrt{P_{70} \times R}$ $\leq 100 \text{ V}$ and $U = 0.3 \times U_{\text{max}}$; (the smaller value is valid) 1000 h	± (0.25 % <i>R</i> + 10 mΩ)	± (0.5 % <i>R</i> + 10 mΩ)	± (1 % <i>R</i> + 10 mΩ)	± (2 % <i>R</i> + 10 mΩ)		





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TEST	PROCEDI	URES AND F	REQUIREMENTS				
EN 60115-1 CLAUSE	IEC 60068-2 ⁽¹⁾ TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (Δ <i>R</i>)			
			Stability for product types:	STABILITY CLASS 0.25 OR BETTER	STABILITY CLASS 0.5 OR BETTER	STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER
			MMU 0102	10 Ω to 221 k Ω	1 Ω to < 10 Ω	< 1 Ω	> 221 kΩ
			MMA 0204 MMB 0207	10 Ω to 332 kΩ 10 Ω to 1 MΩ	1 Ω to < 10 Ω	<1Ω <1Ω	> 332 kΩ > 1 MΩ
4.23		Climatic	MIMIB 0207	10 22 10 1 10122	1 77 10 < 10 75	< 177	> 1 1/1/2
	0 (DF)	sequence:	LIOT. 10 h				
4.23.2 4.23.3	2 (Bb) 30 (Db)	Dry heat Damp heat, cyclic	UCT; 16 h 55 °C; 24 h; ≥ 90 % RH;				
4.23.4	1 (Ab)	Cold	1 cycle LCT; 2 h	(2.15.0/.5	(2.5.a.)	44.04.5	44.04.5
4.23.5	13 (M)	Low air pressure	8.5 kPa; 2 h; (25 ± 10) °C	± (0.15 % <i>R</i> + 10 mΩ)	± (0.5 % <i>R</i> + 10 mΩ)	± (1 % <i>R</i> + 10 mΩ)	± (1 % <i>R</i> + 10 mΩ)
4.23.6	30 (Db)	Damp heat,	55 °C; 24 h; ≥ 90 % RH; 5 cycles				
4.23.7	-	DC load	$U = \sqrt{P_{70} \times R} \le U_{\text{max.}};$ 1 min. LCT = -55 °C; UCT = 155 °C				
-	1 (Ab)	Cold	- 55 °C; 2 h	± (0.05 % <i>R</i> + 5 mΩ)			± (0.1 % <i>R</i> + 5 mΩ)
			30 min at LCT; 30 min at UCT; LCT = - 55 °C; UCT = 125 °C				. o masy
		Rapid change	5 cycles	±	(0.05 % R + 10 mg	2)	± (0.1 % <i>R</i> + 10 mΩ)
4.19	14 (Na)	of temperature	1000 cycles	±	\pm (0.15 % R + 10 mΩ)		
			LCT = - 55 °C; UCT = 155 °C				
			1000 cycles	±	(0.25 % R + 10 mg	2)	± (0.5 % <i>R</i> + 10 mΩ)
4.10		Short time overload: Standard operation mode	$U = 2.5 \times \sqrt{P_{70} \times R}$	£	± (0.03 % <i>R</i> + 5 mΩ	2)	± (0.15 % <i>R</i> + 5 mΩ)
4.13	-	Short time overload: Power operation mode	- ≤2 x Ü _{max.} ; 5 s	4	± (0.05 % <i>R</i> + 5 mΩ	2)	± (0.15 % <i>R</i> + 5 mΩ)
4.27	_	Single pulse high voltage overload: Standard operation mode	Severity no. 4: $U = 10 \times \sqrt{P_{70}} \times R$		± (0.25 %	R + 5 mΩ)	
4.61	-	Single pulse high voltage overload: Power operation mode	$\leq 2 \times U_{\text{max.}};$ 10 pulses 10 µs/700 µs		± (0.5 % /	P + 5 mΩ)	



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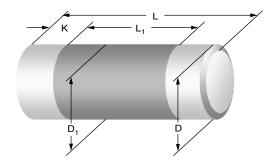
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TEST	PROCEDI	URES AND F	REQUIREMENTS					
EN 60115-1 CLAUSE	IEC 60068-2 ⁽¹⁾ TEST METHOD	TEST	PROCEDURE			EMENTS E CHANGE (Δ <i>R</i>)		
			Stability for product types:	STABILITY CLASS 0.25 OR BETTER	STABILITY CLASS 0.5 OR BETTER	STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER	
			MMU 0102	10 Ω to 221 k Ω	1 Ω to < 10 Ω	<1Ω	> 221 kΩ	
			MMA 0204	10 Ω to 332 kΩ	1 Ω to < 10 Ω	<1Ω	> 332 kΩ	
			MMB 0207	10 Ω to 1 MΩ	1 Ω to < 10 Ω	< 1 Ω	> 1 MΩ	
4.37	_	Periodic electric overload: Standard operation mode	$U = \sqrt{15 \times P_{70} \times R}$ $\leq 2 \times U_{\text{max}}$		± (0.5 % /	$R+5$ m Ω)		
		Periodic electric overload: Power operation mode	0.1 s on; 2.5 s off; 1000 cycles		± (1 % F	? + 5 mΩ)		
4.22	6 (Fc)	Vibration	Endurance by sweeping; 10 Hz to 2000 Hz; no resonance; amplitude ≤ 1.5 mm or ≤ 200 m/s²; 7.5 h	± (0.05 % R + 5 mΩ)				
4.40	-	Electrostatic discharge (Human Body Model)	IEC 61340-3-1 ⁽¹⁾ ; 3 pos. + 3 neg. discharges MMU 0102: 1.5 kV MMA 0204: 2 kV MMB 0207: 4 kV	± (0.5 % R + 0.05 Ω)				
			Solder bath method; SnPb40; non-activated flux; (215 ± 3) °C; (3 ± 0.3) s	Good	tinning (≥ 95 % co	vered); no visible da	amage	
4.17.2	58 (Td)	Solderability	Solder bath method; SnAg3Cu0.5 or SnAg3.5; non-activated flux; (235 ± 3) °C; (2 ± 0.2) s	Good	tinning (≥ 95 % co	vered); no visible da	amage	
		Desistance	Solder bath method; (260 ± 5) °C; (10 ± 1) s	± (0.05 % <i>R</i> + 10 mΩ)	± (0.1 % <i>R</i> + 10 mΩ)	± (0.25 % <i>R</i> + 10 mΩ)	± (0.25 % <i>R</i> + 10 mΩ)	
4.18.2	58 (Td)	Resistance to soldering heat	Reflow method 2 (IR/forced gas convection); (260 ± 5) °C; (10 ± 1) s	± (0.02 % R + 10 mΩ)	± (0.05 % R + 10 mΩ)	± (0.05 % <i>R</i> + 10 mΩ)	± (0.1 % <i>R</i> + 10 mΩ)	
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol; 50 °C; method 2	No visible damage				
4.30	45 (XA)	Solvent resistance of marking	Isopropyl alcohol; 50 °C; method 1, toothbrush	Marking legible; no visible damage				
4.32	21 (Ue ₃)	Shear (adhesion)	45 N		No visible	e damage		
4.33	21 (Ue ₁)	Substrate bending	Depth 2 mm, 3 times	No visi	± (0.05 % F	pen circuit in bent property $(2)^{(2)}$	osition	
4.7	-	Voltage proof	$U_{\rm RMS} = U_{\rm ins}; 60 \text{ s}$		No flashover	or breakdown		
4.35	-	Flammability	IEC 60695-11-5 ⁽¹⁾ , needle flame test; 10 s		No burning	g after 30 s		

- Notes
 (1) The quoted IEC standards are also released as EN standards with the same number and identical contents.
 (2) Special requirements apply to MICRO-MELF, MMU 0102:
 R < 100 Ω: ± (0.25 % R + 10 mΩ)
 100 Ω ≤ R ≤ 221 kΩ: ± 0.1 % R
 221 kΩ < R: ± 0.25 % R

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DIMENSIONS

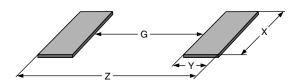


DIMENSIONS AND MASS									
TYPE/SIZE	L (mm)	D (mm)	L _{1 min.} (mm)	D ₁ (mm)	K (mm)	MASS (mg)			
MMU 0102	2.2 + 0/- 0.1	1.1 + 0/- 0.1	1.2	D + 0/- 0.1	0.4 ± 0.05	8			
MMA 0204	3.6 + 0/- 0.2	1.4 + 0/- 0.1	1.8	D + 0/- 0.15	0.8 ± 0.1	22			
MMB 0207	5.8 + 0/- 0.15	2.2 + 0/- 0.2	3.2	D + 0/- 0.2	1.25 ± 0.1	80			

Note

Color code marking is applied according to IEC 60062 ⁽¹⁾ in four bands (E24 series) or five bands (E96 or E192 series). Each color band appears as a single solid line, voids are permissible if at least ²/₃ of the band is visible from each radial angle of view. The last color band for tolerance is approximately 50 % wider than the other bands. An interrupted yellow band between the 4th and 5th full band indicates TC25.

PATTERN STYLES FOR MELF RESISTORS



RECOMMENDED SOLDER PAD DIMENSIONS									
WAVE SOLDERING					REFLOW SOLDERING				
TYPE/SIZE	G (mm)	Y (mm)	X (mm)	Z (mm)	G (mm)	Y (mm)	X (mm)	Z (mm)	
MMU 0102	0.7	1.2	1.5	3.1	1.1	0.8	1.3	2.7	
MMA 0204	1.5	1.5	1.8	4.5	1.7	1.2	1.6	4.1	
MMB 0207	2.8	2.1	2.6	7.0	3.2	1.7	2.4	6.6	

Notes

- The rated dissipation applies only if the permitted film temperature is not exceeded. Furthermore, a high level of ambient temperature or of power dissipation may raise the temperature of the solder joint, hence special solder alloys or board materials may be required to maintain the reliability of the assembly. Specified power rating above 125 °C requires dedicated heat-sink pads, which to a great extend depend onboard materials and design. The given solder pad dimensions reflect the considerations for board design and assembly as outlined e.g. in standards IEC 61188-5-x ⁽¹⁾, or in publication IPC-7351. They do not guarantee any supposed thermal properties, particularly as these are also strongly influenced by many other parameters.
 - Still, the given solder pad dimensions will be found adequate for most general applications, e.g. those referring to "standard operation mode". Please note however that applications for "power operation mode" require special considerations for the design of solder pads and adjacent conductor areas.
- (1) The quoted IEC standards are also released as EN standards with the same number and identical contents.



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HISTORICAL 12NC INFORMATION

- The resistors had a 12-digit numeric code starting with 2312.
- The subsequent 4 digits indicated the resistor type, specification and packaging; see the 12NC table.
- The remaining 4 digits indicated the resistance value:
 - The first 3 digits indicated the resistance value.
 - The last digit indicated the resistance decade in accordance with the 12NC Indicating Resistance Decade table.

Last Digit of 12NC Indicating Resistance Decade

RESISTANCE DECADE	LAST DIGIT
0.1 Ω to 0.999 Ω	7
1 Ω to 9.99 Ω	8
10 Ω to 99.9 Ω	9
100 Ω to 999.9 Ω	1
1 k Ω to 9.99 k Ω	2
10 k Ω to 99.9 k Ω	3
100 k Ω to 999 k Ω	4
1 M Ω to 9.99 M Ω	5
10 M Ω to 99.9 M Ω	6

Historical 12NC

The 12NC of a MMU 0102 resistor, value 47 k Ω . and TCR 50 with \pm 1 % tolerance, supplied in blister tape of 3000 units per reel is: 2312 165 14703.

HISTORICAL	12NC - Resistor type	and packaging				
	DECODIDATION		2312			
	DESCRIPTION		BLISTER TA	PE ON REEL	BULK CASE	
TYPE	TCR	TOL.	BL 3000 UNITS	B0 10 000 UNITS	M8 8000 UNITS	
		± 5 %	165 3	175 3	060 3	
	. 50 nnm/V	± 2 %	165 2	175 2	060 2	
	± 50 ppm/K	± 1 %	165 1	175 1	060 1	
MMU 0102		± 0.5 %	165 5	175 5	060 5	
	. 05 nnm/V	± 1 %	166 1	176 1	061 1	
	± 25 ppm/K	± 0.5 %	166 5	176 5	061 5	
	Jum	Jumper		175 90001	060 90001	
TYPE	TCR	TOL.	BL 3000 UNITS	B0 10 000 UNITS	M3 3000 UNITS	
	± 50 ppm/K	± 5 %	155 3	145 3	040 3	
		± 1 %	155 1	145 1	040 1	
MMA 0204		± 0.5 %	155 5	145 5	040 5	
IVIIVIA UZU4	. 05 nnm/V	± 1 %	156 1	146 1	041 1	
	± 25 ppm/K	± 0.5 %	156 5	146 5	041 5	
	Jum	per	155 90001	145 90001	040 90001	
ТҮРЕ	TCR	TOL.	B2 2000 UNITS	B7 7000 UNITS		
	± 100 ppm/K	± 5 %	195 3	185 3		
MMB 0207		± 5 %	195 3	185 3		
	± 50 ppm/K	± 2 %	195 2	185 2		
		± 1 %	195 1	185 1		
	± 25 ppm/K	± 0.5 %	196 5	186 5		
	Jum	Jumper		185 90001		



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MMB02070C6808FB200	MMU01020C1003FB300	MMU01020C1502FB300	MMB02070C5603FB200
MMB02070C1003FB200	MMA02040C6808FB300	MMB02070C1009FB700	MMA02040C1008FB300
MMA02040C1500FB300	MMA02040C8200FB300	MMA02040C1001FB300	MMA02040C1201FB300
MMA02040C3309FB300	MMA02040C1273FB300	MMA02040C1302FB300	MMA02040C1332FB300
MMA02040C1372FB300	MMA02040C1432FB300	MMA02040C1472FB300	MMA02040C1582FB300
MMA02040C1692FA300	MMA02040C2492FB300	MMA02040C2552FB300	MMA02040C3012FA300
MMA02040C3402FB300	MMA02040C3741FB300	MMA02040C6812FB300	MMA02040C7152FB300
MMB02070C1508FB200	MMU01020C1209FB300	MMU01020C7501FB300	MMB02070C1203FB200
MMB02070C2700FB200	MMB02070C6800FB200	MMA02040C2708FB000	MMA02040C3308FB300
MMU01020C7509FB300	MMA02040E2003BB300	MMU01020C1001FB300	MMU01020C1503FB300
MMU01020C7502FB300	MMB02070C1000FB700	MMB02070C1001FB700	MMA02040C1008FB000
MMA02040C1803FB000	MMU01020C3002FB300	MMU01020C3001FB300	MMB02070C2709FB700
MMU01020C3322FB300	MMU01020C4992FB300	MMU01020C7503FB300	MMB02070C1208FB200
MMB02070C3900FB200	MMB02070C5601FB200	MMB02070C2001FB200	MMA02040C2213FB300
MMA02040C2201FB000	MMB02070C1201FB200	MMU01020C4700FB300	MMU01020C4702FB300
MMA02040D1002BB300	MMA02040C5620FB300	MMA02040C1212FB300	MMA02040C3929FB300
MMB02070C1202FB200	MMB02070C3301FB200	MMB02070C4702FB200	MMB02070C1200FB200
MMA02040E1000BB300	MMA02040C5109FB300	MMA02040C8202FB000	MMA02040C1002DB000
MMA02040C1002DB300	MMA02040C1005FB000	MMA02040C1009FB000	MMA02040C1102FB000
MMA02040C1200FB000	MMA02040C1201FB000	MMA02040C1202FB000	MMA02040C1203FB000
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MMA02040C1211FB000	MMA02040C1212FB000	MMA02040C1302FB000	MMA02040C1500FB000
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